## **NCE N-Channel Super Trench Power MOSFET**

#### **Description**

The NCEP4090GU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

#### **General Features**

● V<sub>DS</sub> =40V,I<sub>D</sub> =90A

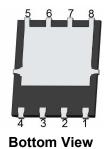
 $R_{DS(ON)}$ =2.2m $\Omega$  (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =3.3m $\Omega$  (typical) @  $V_{GS}$ =4.5V

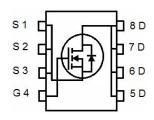
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

#### **DFN 5X6**







**Schematic Diagram** 

### **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Device Package	Reel Size	Tape width	Quantity
P4090GU	NCEP4090GU	DFN5x6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25 ℃unless otherwise noted)

Par	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	40	V	
Gate-Source Voltage	V <sub>G</sub> s	±20	V	
Drain Current-Continuous	(T <sub>C</sub> =25℃)	- I <sub>D</sub>	90	Α
Drain Current-Continuous	(T <sub>C</sub> =100℃)		63.6	<b>A</b>
M : D D: : ::	(T <sub>C</sub> =25℃)	- P <sub>D</sub>	85	W
Maximum Power Dissipation	(Tc=100°C)		34	
Pulsed Drain Current	I <sub>DM</sub>	360	А	
Derating factor		0.68	W/℃	
Single pulse avalanche energy	E <sub>AS</sub>	500	mJ	
Operating Junction and Storage	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$	



# NCEP4090GU

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	1.47	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.47	°C/W

### Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	,		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	40		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.0	1.5	2.2	V
Davis Course On Otata Basistana		V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	2.2	2.75	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	3.3	4.0	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =20A		60	-	S
Dynamic Characteristics						
Input Capacitance	C <sub>lss</sub>	\/ -20\/\/ -0\/	-	2300	-	PF
Output Capacitance	Coss	$V_{DS}=20V, V_{GS}=0V,$	-	740	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	38	-	PF
Switching Characteristics (Note 2)			•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	7.5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =20 $V$ , $I_D$ =20 $A$	-	4.0	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =1.6 $\Omega$	-	37	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	7.5	-	nS
Total Gate Charge	Qg	V -20VI -20A	-	40	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=20V, I_{D}=20A,$	-	5.8		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	7.2		nC
Drain-Source Diode Characteristics					•	
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-		1.2	V
Diode Forward Current	Is		-	-	90	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = I <sub>S</sub>	-	14	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	21	-	nC

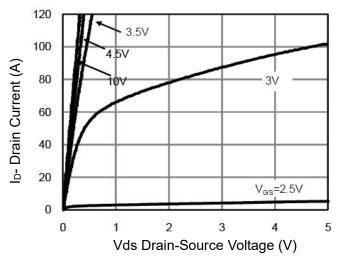
#### Notes:

<sup>1.</sup> EAS condition : Tj=25  $^{\circ}\text{C}\text{,V}_{\text{DD}}\text{=}20\text{V,V}_{\text{G}}\text{=}10\text{V,L=}0.5\text{mH,Rg=}25\Omega$ 

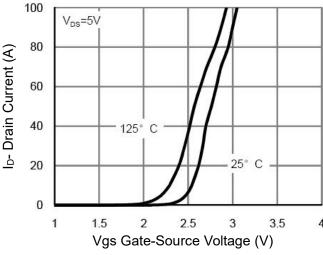
<sup>2.</sup> Guaranteed by design, not subject to production

<sup>3.</sup> These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of  $TJ(MAX)=150^{\circ}$  C. The SOA curve provides a single pulse rating.

### **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

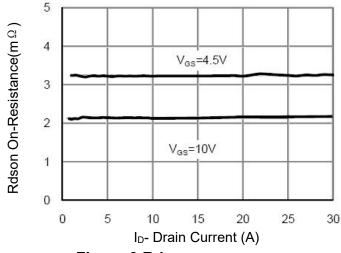


Figure 3 Rdson- Drain Current

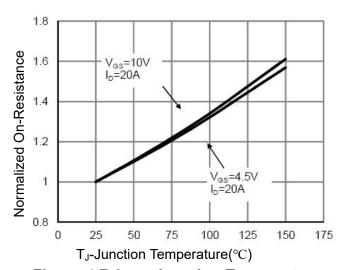
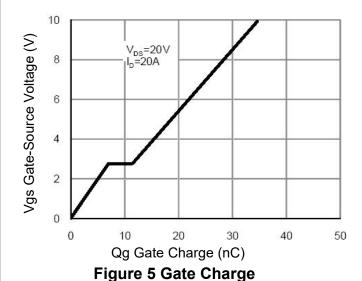
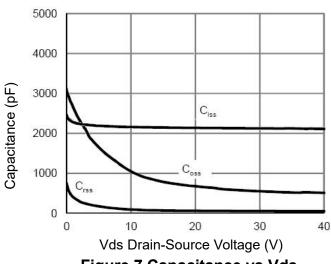


Figure 4 Rdson-Junction Temperature



1.0E+01 Reverse Drain Current (A) 1.0E+00 125° C 1.0E-01 1.0E-02 25° C 1.0E-03 1.0E-04 <u>"</u>s 1.0E-05 0.4 0.8 0.0 1.0 Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



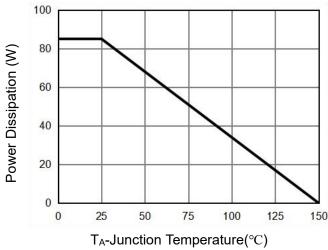
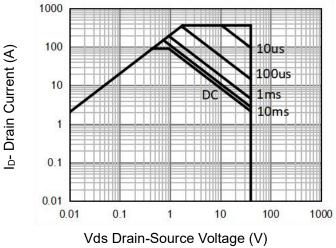


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



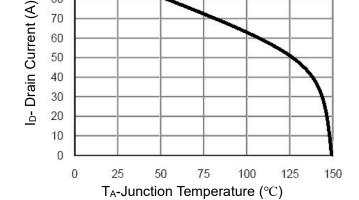


Figure 8 Safe Operation Area (Note 3)

Figure 10 Current De-rating

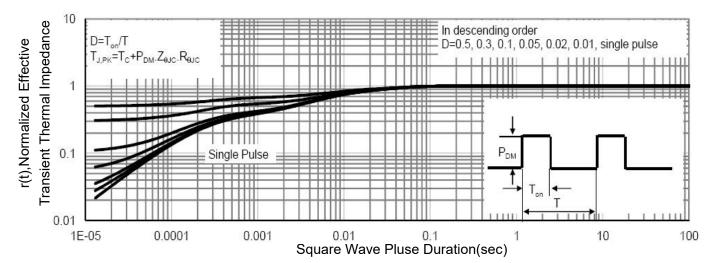
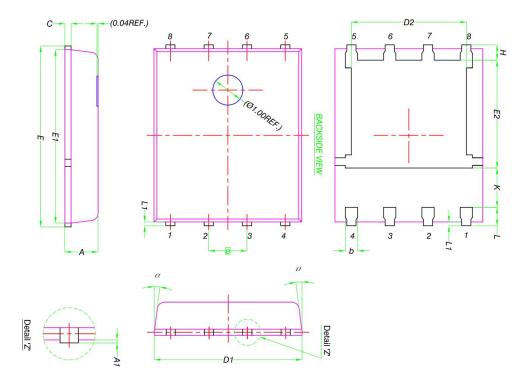


Figure 11 Normalized Maximum Transient Thermal Impedance

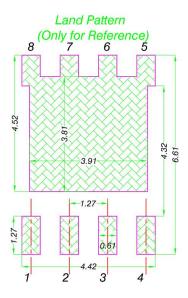
100

90 80

### DFN5X6-8L(G) Package Information



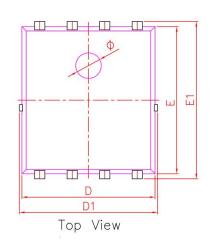
DIM.	MILLIMETERS			
	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
K	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α <b>0</b> °		-	12°	

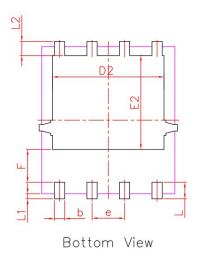


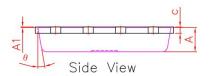
#### Note:

- 1. All Dimension Are In mm.
- Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Tie Bar, Tie Bar Burrs, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.
- 4. The Package Top May Be Smaller Than The Package Bottom.

# DFN5X6-8L(E) Package Information







PDFN5X6-8L						
DIM.	MIN.	NOM.	MAX.			
Α	0.90	0.95	1.00			
A1	0.00	0.02	0.05			
b	0.35	0.40	0.50			
С	0.20	0.25	0.30			
D	5.10	5.20	5.30			
D1	5.10	5.40	5.50			
D2	4.25	4.35	4.45			
е		1.27 BSC				
Е	5.70	5.75	5.80			
E1	6.00	6.15	6.30			
E2	3.57	3.67	3.77			
F	1.18	1.28	1.38			
L	0.55	0.65	0.75			
L1	0.15	0.20	0.25			
L2	0.45	0.55	0.65			
Ø	0.90	1.00	1.10			
Θ	8°	10°	12°			
All dimensions in millimeters						

# NCEP4090GU

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